

Problem:

Joining Nitinol to itself and to other alloys tends to be difficult, as the outside oxide layer does not promote good solder wetting. Using a WES51 soldering iron, we joined Nitinol wire samples using a variety of fluxes and solders. The joined samples were tested for strength in tension.

Objective:

The intent of this experiment was to determine which flux and solder combination will maximize the amount of force it takes to break the soldered bond when joining .016" etched straight annealed Nitinol wire.

Data Collection:

A full factorial experiment was used to test three varieties of fluxes on each of four solder types. Each combination of solder and flux was replicated five times. After each bond was soldered, the breakload was measured using an Instron tension tester.

Data Set:

Variable	Description	Values
Flux	Type of flux applied to the overlapped wires	Flux #2, Flux #3, Flux 400, Flux 5RMA, Flux 5R, Flux 5RA, Flux 4R
Solder	Type of solder applied to overlapped wires	96 Sn/ 4 Ag, 80 Au/20 Sn, 95.5 Sn/3.8 Ag/.7 Cu, 96.5 Sn/ 3.5 Ag
Breakload	Amount of force required to break solder bond	Breakload Values (lbf)

Material Suppliers

Supplier		Material
	Fluxes :Flux #2	Solders: 96 Sn/4 Ag
Indium Corporation of America	Flux #3	96.5 Sn/3.5 Ag
1676 Lincoln Avenue	Flux 5RMA	80 Au/20 Sn
Utica, NY 13502	Flux 5R	
(315) 853-4900	Flux 5RA	
	Flux 4R	
Memory Metalle		
Am Kesselhaus 5	Fluxes: Flux 400	Solders: 95.5 Sn/3.8 Ag/ .7 Cu
D-79576 Weil am Rhein +49. (0)7621 799 121		

General Full Factorial Design Example with Actual Values:

Std Order	Run Order	Blocks	Flux	Solder	Breakload (lbf)
59	1	5	Flux #3	80 Au/20 Sn	18.389
51	2	5	Flux 400	80 Au/20 Sn	8.682



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54	3	5	Flux #2	96.5 Sn/3.5 Ag	42.808
53	4	5	Flux #2	96 Sn/4 Ag	27.432
50	5	5	Flux 400	96.5 Sn/3.5 Ag	30.163
57	6	5	Flux #3	96 Sn/4 Ag	24.515
56	7	5	Flux #2	95.5 Sn/3.8 Ag/.7 Cu	19.547
52	8	5	Flux 400	95.5 Sn/3.8 Ag/.7 Cu	37.707
49	9	5	Flux 400	96 Sn/4 Ag	33.643
55	10	5	Flux #2	80 Au/20 Sn	10.283
58	11	5	Flux #3	96.5 Sn/3.5 Ag	45.274
60	12	5	Flux #3	95.5 Sn/3.8 Ag/.7 Cu	22.206

^{*}All combinations were run 5 times each totaling 60 trials.

Fluxes: Flux #2, Flux #3, Flux 400, 5RMA, 5R, 5RA, 4R. 5RMA, 5R, 5RA, 4R were found not to work on Nitinol because the flux prevented the solder from wetting to the metal.



Solders: 96 Sn/4 Ag, 80 Au/20 Sn, 95.5 Sn/3.8 Ag/.7 Cu, 96.5 Sn/3.5 Ag



Design:

In this full factorial design, fluxes with three levels (Flux #2, Flux #3, Flux 400) and solders with four levels (96 Sn/4 Ag, 80 Au/20 Sn, 95.5 Sn/3.8 Ag/.7 Cu, 96.5 Sn/3.5 Ag) were tested. Replicating each combination five times resulted in 60 runs.

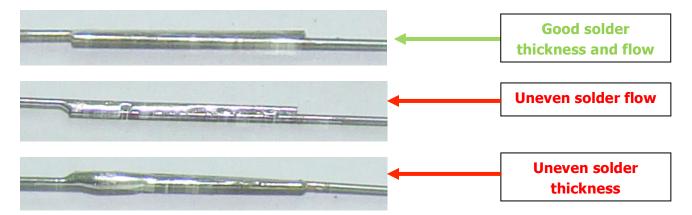
Limitations:

The runs were not followed in a random order to allow for more efficient test times. Another limitation was the soldering iron temperature. Once the iron was past 550°C, the tip oxidized, making solder flow very difficult. There were also many inconsistencies in breakload data. These inconsistencies were due to the amount of solder on each bond, the thickness of solder applied to the



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bond, the oxidation in the solder and on the iron tip, the amount of wire overlap, the amount of flux used, and the solder iron temperature. Below are some examples of *acceptable* soldered bonds and *unacceptable* soldered bonds.



Analysis and Interpretation:

Multilevel Factorial Design

General Linear Model: Breakload versus Blocks, Flux, Solder

Factor	Туре	Levels	Values		
Blocks	Fixed	5	1,2,3,4,5		
Flux	Flux Fixed 3		Flux 400, Flux #2, Flux #3		
Solder	Fixed	4	96 Sn/4 Ag, 96.5 Sn/3.5 Ag, 80 Au/20 Sn, 95.5 Sn/3.8 Ag/.7 Cu		

Factors:	2	Replicates:	5
Base Runs:	12	Total Runs:	60
Base Blocks:	1	Total Blocks:	5



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Analysis of Variance for Breakload, using Adjusted Sum of Squares (SS) for Tests

Source	DF	Seq SS	Adj SS	Adj MS	F	Р
Blocks	4	38.07	38.07	9.52	0.26	0.903
Flux	2	29.25	29.25	14.63	0.40	0.675
<mark>Solder</mark>	<mark>3</mark>	<mark>2530.05</mark>	<mark>2530.05</mark>	<mark>843.35</mark>	<mark>22.86</mark>	<mark>0.000</mark>
Flux*Solder	6	274.19	274.19	45.70	1.24	0.305
Error	44	1623.15	1623.15	36.89		
Total	59	4494.72			-	

*S = 6.07370 R-Sq = 63.89% R-Sq(adj) = 51.58%

=Significant

Unusual Observations for Breakload

Obs	Breakload	Fit	SE Fit	Residual	St Resid
11	45.2740	34.3882	3.1364	10.8858	2.09 R
36	46.2280	34.7411	3.1364	11.4869	2.21 R
39	43.5930	29.0969	3.1364	14.4961	2.79 R
44	17.6740	31.3319	3.1364	-13.6579	-2.63 R

^{*}R denotes an observation with a large standardized residual.

General Linear Model: Breakload versus Blocks, Solder

Factor	Туре	Levels	Values
Blocks	Fixed	5	1,2,3,4,5
Solder	Fixed	4	96 Sn/4 Ag, 96.5 Sn/3.5 Ag, 80 Au/20 Sn, 95.5 Sn/3.8 Ag/.7 Cu

Analysis of Variance for Breakload, using Adjusted SS for Tests

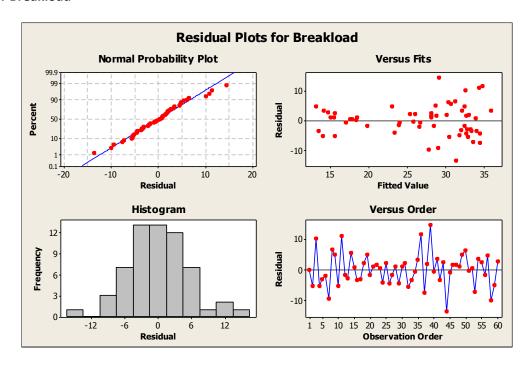
Source	DF	Seq SS	Adj SS	Adj MS	F	Р
Blocks	4	38.07	38.07	9.52	0.26	0.904
<mark>Solder</mark>	<mark>3</mark>	<mark>2530.05</mark>	<mark>2530.05</mark>	<mark>843.35</mark>	<mark>22.76</mark>	<mark>0.000</mark>
Error	52	1926.60	1926.60	37.05		
Total	59	4494.72			•	

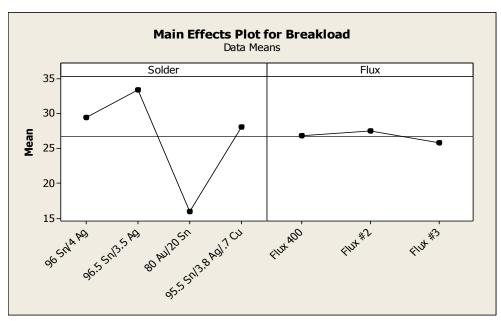
*S = 6.08687 R-Sq = 57.14% R-Sq(adj) = 51.37%

=Significant



Plots for Breakload



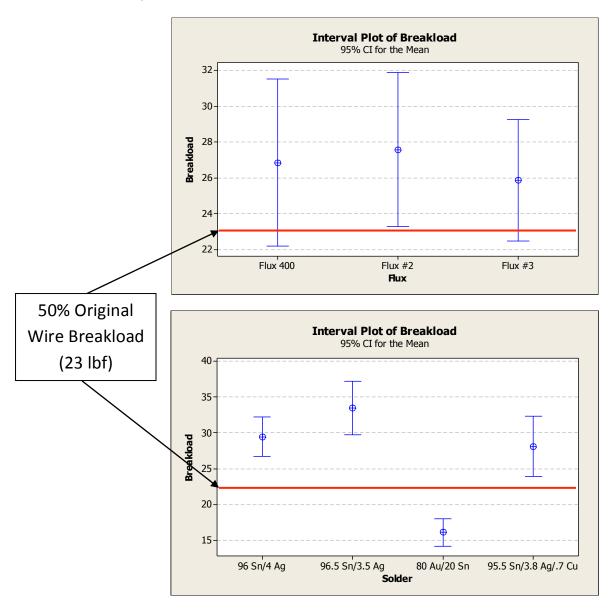


The solder was the only factor that proved to be significant in this experiment while the blocks, flux, and the combination of flux and solder did not. The data followed a normal distribution as shown in



the residual plots for breakload. The main effects plot indicates that the 96.5 Sn/3.5 Ag solder and the Flux #2 produced the highest breakload.

Statistical Analysis of Breakload



However, the interval plots of breakload show that the 96.5 Sn/3.5 Ag solder had a larger confidence interval than the 80 Au/ 20 Sn solder. The larger interval shows a larger standard deviation, meaning there is larger variability with the 96.5 Sn/3.5 Ag solder. While the 80 Au/ 20 Sn solder provided a lower breakload, it was a more consistent and reproducible solder than the 96.5 Sn/3.5 Ag



solder. The fluxes were all comparable but the Flux #2 provided the highest mean and the Flux #3 gave the lowest variability in breakload strength.

Recommendations:

When soldering Nitinol, the customer prefers the breakload of the bond to be as large as possible (at least 50% the breakload of the wire). The ideal goal is for the wire to break before the bond breaks. Here is a list of solder and flux recommendations that will achieve these goals:

- Flux This factor does not greatly influence the breakload of the bond. However, as determined by the main effects plot, Flux #2 did provide the highest breakload by a small amount while Flux #3 had the lowest variability in breakload strength. Also, the more flux applied to the seam, the easier the solder flow.
- Solder This factor greatly influences the breakload of the bond. The 96.5 Sn/3.5 Ag solder provided the highest breakload average while the 80 Au/ 20 Sn solder provided the lowest breakload average as determined by the main effects plot. To achieve a higher breakload average and a lower variability in breakload strength, the 96.5 Sn/3.5 Ag solder should be used.
- **Solder Iron Temperature-** The soldering iron temperature should not exceed 550°C. At higher temperatures, the iron tip oxidizes, making solder flow very difficult.

About Fort Wayne Metals

Fort Wayne Metals is a leading manufacturer of medical grade materials. We are FDA registered and ISO 9001 and AS9100 certified. Fort Wayne Metals offers access to an unparalleled breadth of materials, including round wire, flat wire in a variety of shapes, rod, strands, cables, DFT® composites, DBS®, HHS® Tube, SLT® Wire, titanium and titanium alloys, Nitinol and a range of high performance alloys. An expert in Nitinol manufacturing, Fort Wayne Metals has pioneered many improvements − such as DPS™, a Nitinol wire processed to significantly increase plateau strength. To find out more about Fort Wayne Metals, visit fwmetals.com.